· Dacket No.

## Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My reside	ence, po	st office address and ci	tizenship are as sta	ated below my nar	ne.				
I believe listed bel (Insert	ow) of t	original, first and sole he subject matter which BODY FRAME S	n is claimed and fo	ne name is listed b or which a patent i	elow) or an orig s sought on the	zinal, first and joint invention entitled	inven	tor (if plural names ar	
the specif	fication	of which is attached he	reto unless the foll	owing box is chec	ked:				
×				was amended on	As PCT Inter	national Applicatio	n		
And/or	was fil Numb		and y	was amended on	As United States Application				
I hereby s	state tha	at I have reviewed and weferred to above.			-identified speci	ification, including	the cl	eim(s), as amended b	
I acknow	ledge th	e duty to disclose infor	nation which is ma	aterial to patentab	ility as defined	in 37 C.F.R. '1.56			
I hereby certificate and have date before	claim f e, or '30 also ido re that o	oreign priority benefits 55(a) of any PCT Internentified below any fore of the application(s) for	s under 35 U.S.C. ational application for which priority is c	' 119(a)-(d) or n which designated patent or invented laimed:	365(b) of any dat least one co r's certificate on	foreign application ountry other than the PCT International	n(s) fo e Unit Appl	or patent or inventor ed States, listed belov ication having a filin	
(List pri foreign applicati	_	P.2004-103569			31/March/2004  (Day/Month/Year Filed)			Claimed  No	
	iona\	P.2004-103961	(Country)  Japan (Country)	31/1	March/2004		Yes	□ No	
		P.2004-104177	Japan (Country)	31/1	March/2004		Yes	□ No	
I hereby o		e benefit under 35 U.S.			•	tion(s) listed below	<b>7.</b>		
		(Application Number)		(Filing Date)		<u> </u>			
		(Application Number)		(Filing Date)		<del></del>			
		☐ See att	ached list for addi	tional prior foreig	n or provisional	applications.			
I hereby designatin disclosed to disclos prior appl (List prior U Applications	e inform lication	ne benefit under 35 U.S Jnited States of Americal or application(s) (U.S nation which is material and the national or PC.	S.C. '120 of any ca listed below an . or PCT) in the m to patentability as International fili	United States app d, insofar as the anner provided by defined in 37 C.F ng date of this app	lication(s) or 'subject matter of the first paragrams. R. '1.56 which blication.	365(c) of any PCT of each of the clair aph of 35, U.S.C. ' l became available b	Interns of 112, I petwee	national application(sthis application is not acknowledge the duten the filing date of the	
PCT Internal applications designating t	tional	(Application Serial No.)	(Application Serial No.)		(Filing Date)		(Status) (patented, pending, abandoned)		
	•	(Application Serial No.)		(Filing Date)		(Status) (patented, pending, abar			
And I he 22,980; C Reg. No. Reg. No. Jonathan 37,500; a	reby ap Charles N 44,275; 48,898 A. Kid nd Char	point the firm of Aren Marmelstein, Reg. N Robert K. Carpenter, I ; Brian A. Tollefson, I ney, Reg. No. 46,195; les Buskey, Reg. No. 4	t Fox, Customer 1 o. 25,895; George Reg. No. 34,794; F Reg. No. 46,338, Bala Sundararajan 6,592.	Number 004372 i E. Oram, Jr., Reg Rustan Hill, Reg. Lynne D. Anders I, Reg. No. P50,9	ncluding as prin No. 27,931; Ri No. 37,351; Har son, Reg. No. 4 00; Monica Kit	ncipal attorneys: I chard J. Berman, R ns J. Crosby, Reg. I 16,412; D. Daniel ts, Reg. No. 36,10	Robert eg. No No. 44 Dzara 5; Kir	. В. Митау, Reg. № J. 39,107; Murat Ozg 1,634, Lynn A. Bristo II, Reg. No. 47,54: ng L. Wong, Reg. №	
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The under and/or, if any action and the unberso notice.	rsigned the und n to be to ndersign ified by	hereby authorizes the U lersigned is not a reside ake in the Patent and Ti ned. In the event of a c the undersigned.	J.S. attorneys name ent of the United S ademark Office re hange in the perso	ed herein to accept states, the undersi garding this appli- in(s) from whom	and follow inst gned's domestic ation without d nstructions may	ructions from the ucattorney, patent at irect communication be taken, the U.S.	ndersi torney n betv attorr	gned's assignee, if an y or patent agent, as i ween the U.S. attorney neys named herein wi	
I hereby of believed to punishable may jeopa	declare to be tru le by fin ardize tl	that all statements mad ne; and further, that the e or imprisonment, or b ne validity of the applic	e herein of my ow se statements were ooth, under Section ation or any patent	n knowledge are made with the k 1001 of Title 18 t issued thereon.	true and that all nowledge that v of the United St	statements made of willful false statement tates Code and that	n info nts an such	ormation and belief and the like so made as willful false statemen	
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Full name of ninth inventor							
Inventor's signature							
	Date						
Residence							
Citizenship Post Office Address							
1 OPL OTHER MARIES?							